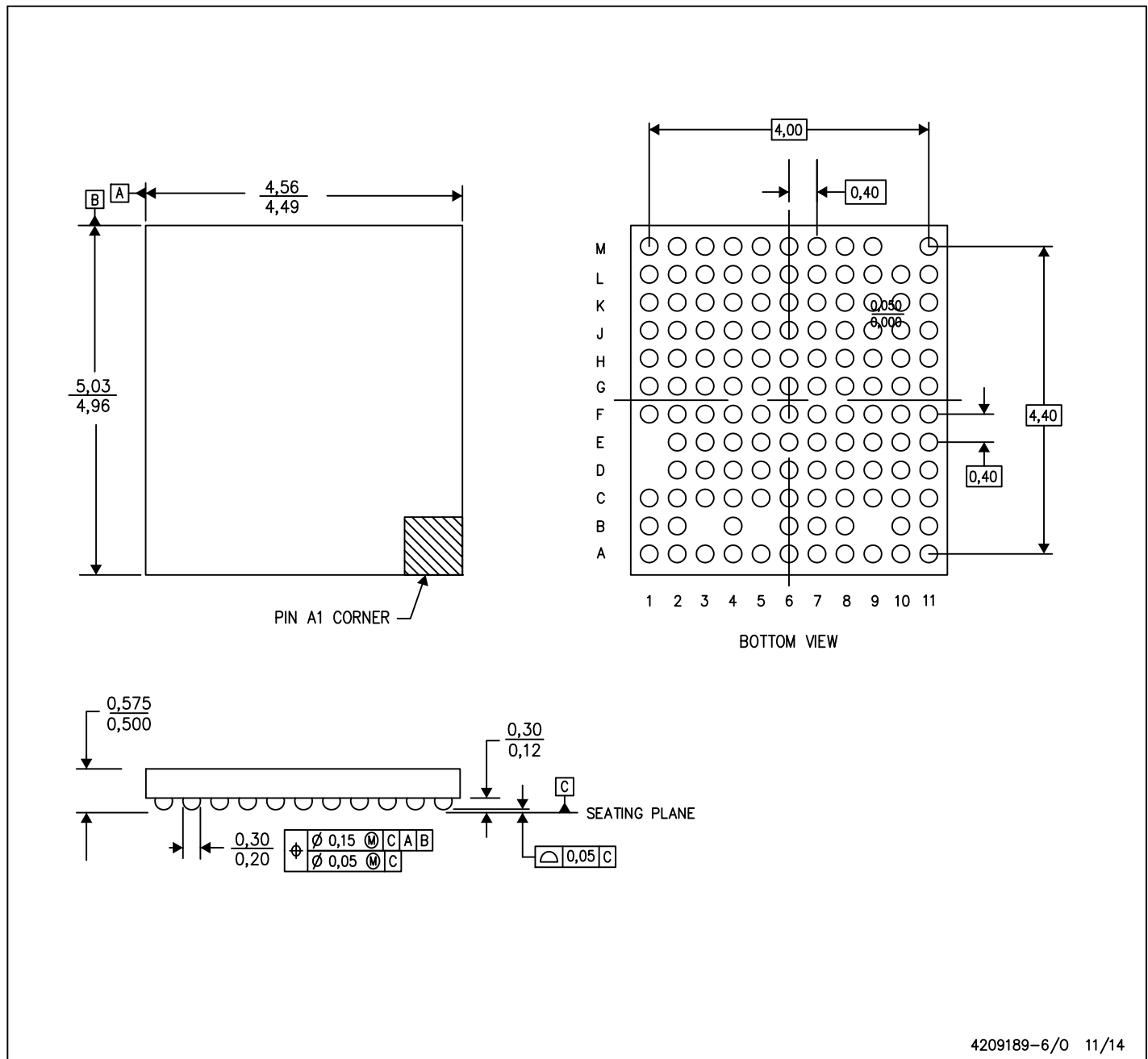


YFV (R-XBGA-N126)

DIE-SIZE BALL GRID ARRAY (WCSP)



4209189-6/O 11/14

- NOTES:
- All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
  - This drawing is subject to change without notice.
  - NanoFree™ package configuration.
  - This package contains Pb-free balls.

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